



**THE DATASHEET OF
AO4830L**

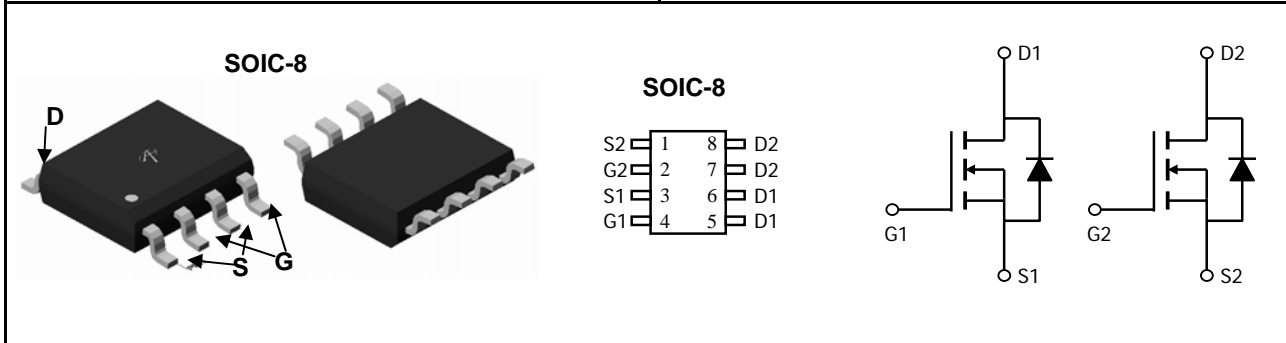




AO4830L

Dual N-Channel Enhancement Mode Field Effect Transistor

| General Description | Features |
|--|--|
| <p>The AO4830L uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.</p> <p>- RoHS Compliant - Halogen Free</p> | <p>V_{DS} (V) = 80V I_D = 3.5A (V_{GS} = 10V) $R_{DS(ON)}$ < 75mΩ (V_{GS} = 10V)</p> <p>100% UIS Tested! 100% R_g Tested!</p> |



| Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted | | | |
|--|----------------|------------------------|------------------|
| Parameter | Symbol | Maximum | Units |
| Drain-Source Voltage | V_{DS} | 80 | V |
| Gate-Source Voltage | V_{GS} | ± 30 | V |
| Continuous Drain Current | I_D | $T_A=25^\circ\text{C}$ | 3.5 |
| | | $T_A=70^\circ\text{C}$ | 2.9 |
| Pulsed Drain Current ^C | I_{DM} | 18 | A |
| Avalanche Current ^C | I_{AR} | 16 | A |
| Repetitive avalanche energy $L=0.1\text{mH}$ ^C | E_{AR} | 12.8 | mJ |
| Power Dissipation ^B | P_D | $T_A=25^\circ\text{C}$ | 2 |
| | | $T_A=70^\circ\text{C}$ | 1.3 |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | $^\circ\text{C}$ |

| Thermal Characteristics | | | | |
|--|-----------------|--------------|------|--------------------|
| Parameter | Symbol | Typ | Max | Units |
| Maximum Junction-to-Ambient ^A | $R_{\theta JA}$ | 48 | 62.5 | $^\circ\text{C/W}$ |
| Maximum Junction-to-Ambient ^{A,D} | | Steady-State | 74 | 90 |
| Maximum Junction-to-Lead | $R_{\theta JL}$ | 32 | 40 | $^\circ\text{C/W}$ |

Electrical Characteristics (T_J=25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------------------------|--|---|-----|-------------|-----------|-------|
| STATIC PARAMETERS | | | | | | |
| B _V DSS | Drain-Source Breakdown Voltage | I _D =250μA, V _{GS} =0V | 80 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =80V, V _{GS} =0V T _J =55°C | | | 1 5 | μA |
| I _{GSS} | Gate-Body leakage current | V _{DS} =0V, V _{GS} = ±30V | | | 100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} I _D =250μA | 3.5 | 4.2 | 5 | V |
| I _{D(ON)} | On state drain current | V _{GS} =10V, V _{DS} =5V | 18 | | | A |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =3.5A T _J =125°C | | 62 113.0 | 75 135 | mΩ |
| g _{FS} | Forward Transconductance | V _{DS} =5V, I _D =3.5A | | 15 | | S |
| V _{SD} | Diode Forward Voltage | I _S =1A, V _{GS} =0V | | 0.77 | 1 | V |
| I _S | Maximum Body-Diode Continuous Current | | | | 2.5 | A |
| I _{SM} | Pulsed Body-diode Current ^c | | | | 18 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =40V, f=1MHz | 510 | 640 | 770 | pF |
| C _{oss} | Output Capacitance | | 28 | 40 | 52 | pF |
| C _{riss} | Reverse Transfer Capacitance | | 12 | 20 | 30 | pF |
| R _g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1MHz | 0.9 | 1.8 | 2.7 | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q _{g(10V)} | Total Gate Charge | V _{GS} =10V, V _{DS} =40V, I _D =3.5A | 8 | 11 | 13 | nC |
| Q _{g(4.5V)} | Total Gate Charge | | 4 | 5.5 | 7 | |
| Q _{gs} | Gate Source Charge | | 4 | 5 | 6 | nC |
| Q _{gd} | Gate Drain Charge | | 0.7 | 1.2 | 1.7 | nC |
| t _{D(on)} | Turn-On DelayTime | V _{GS} =10V, V _{DS} =40V, R _L =8Ω, R _{GEN} =3Ω | | 7.2 | | ns |
| t _r | Turn-On Rise Time | | | 2.2 | | ns |
| t _{D(off)} | Turn-Off DelayTime | | | 17 | | ns |
| t _f | Turn-Off Fall Time | | | 2 | | ns |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =3.5A, dI/dt=300A/μs | 14 | 20 | 26 | ns |
| Q _{rr} | Body Diode Reverse Recovery Charge | I _F =3.5A, dI/dt=300A/μs | 35 | 50 | 65 | nC |

A. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using ≤ 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

D. The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

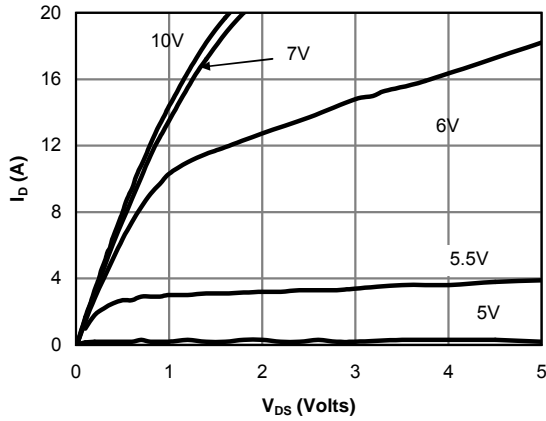


Fig 1: On-Region Characteristics (Note E)

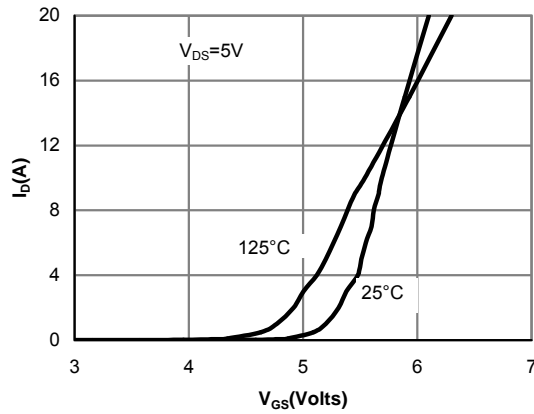


Figure 2: Transfer Characteristics (Note E)

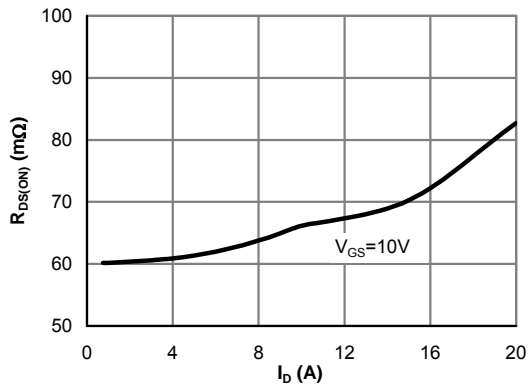


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

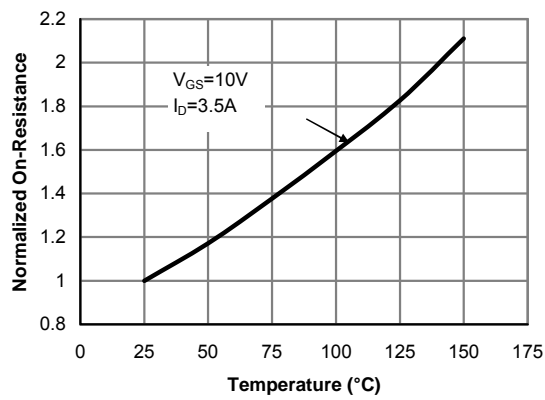


Figure 4: On-Resistance vs. Junction Temperature (Note E)

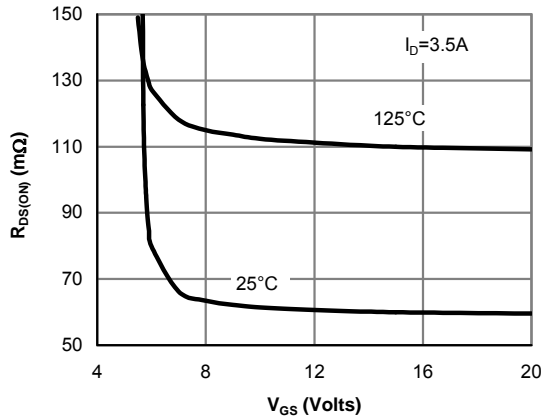


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

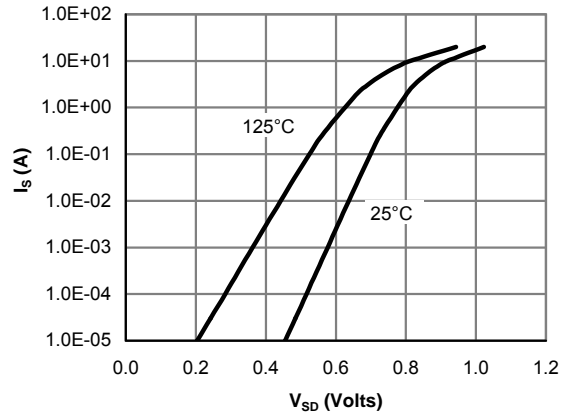


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

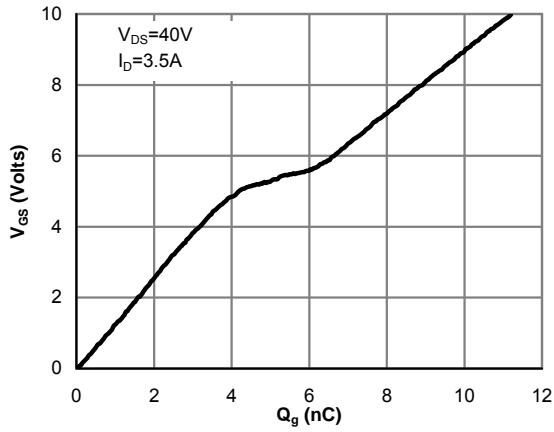


Figure 7: Gate-Charge Characteristics

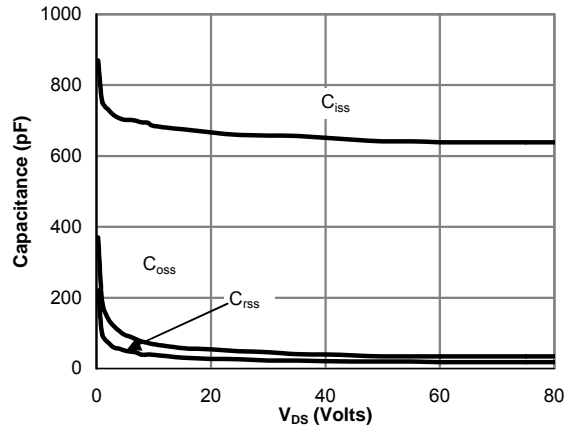


Figure 8: Capacitance Characteristics

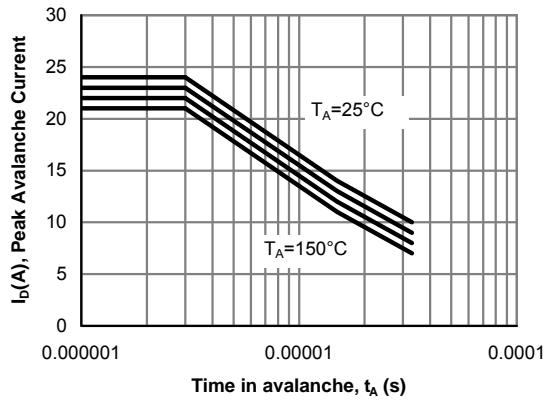


Figure 12: Single Pulse Avalanche capability

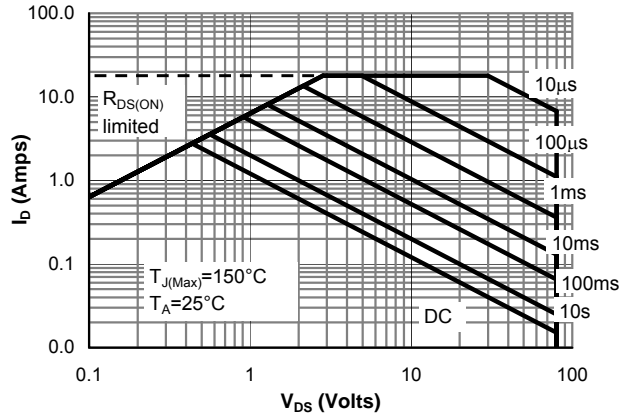


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

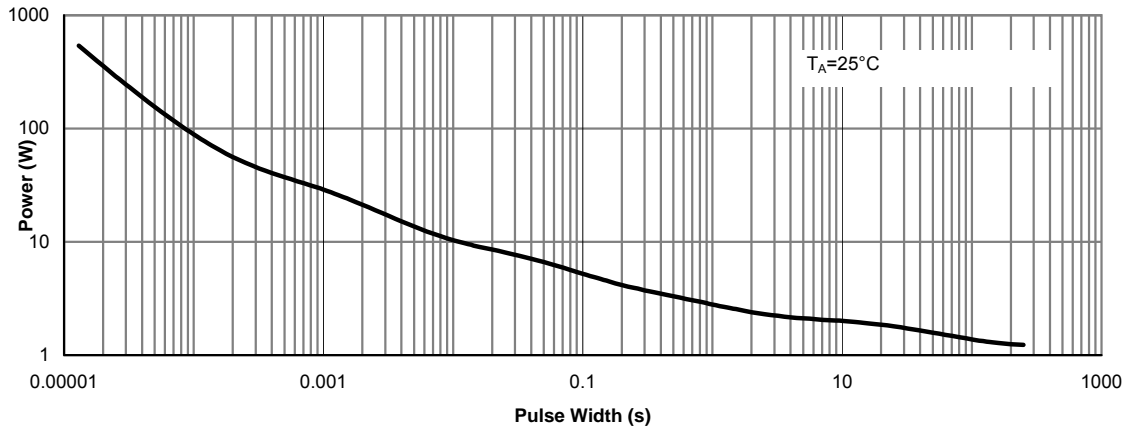


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

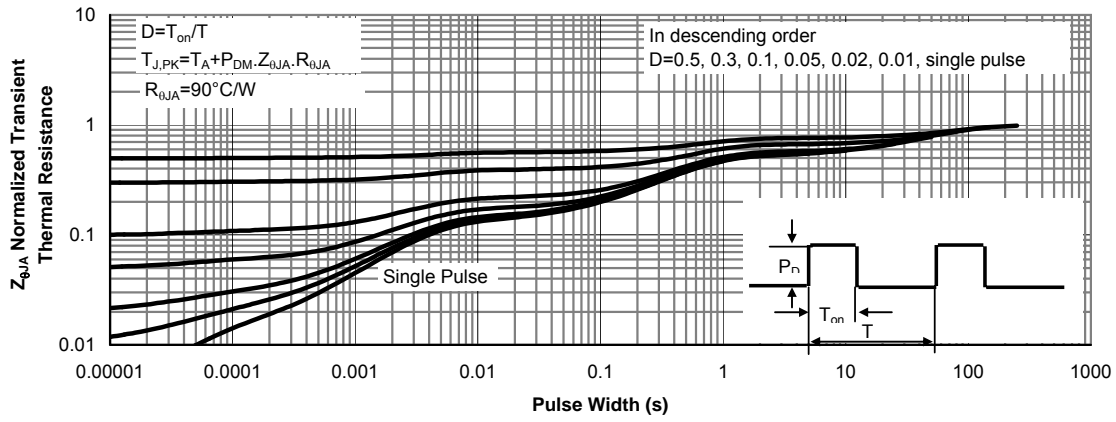
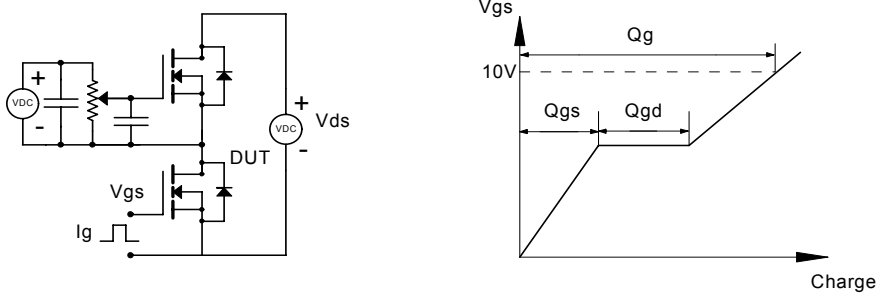
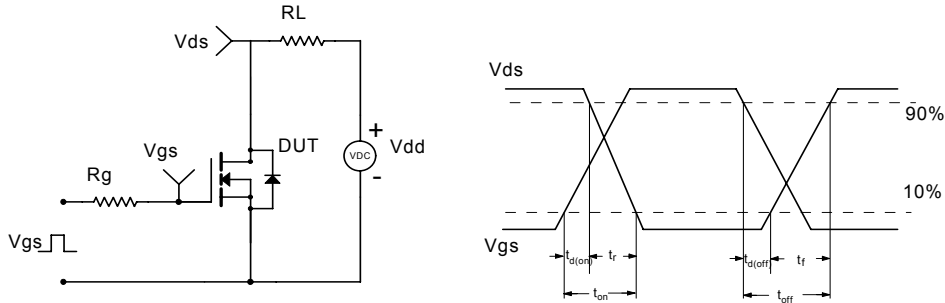


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

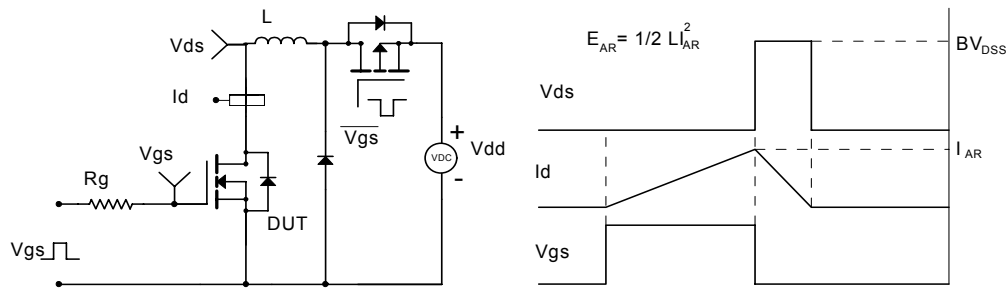
Gate Charge Test Circuit & Waveform



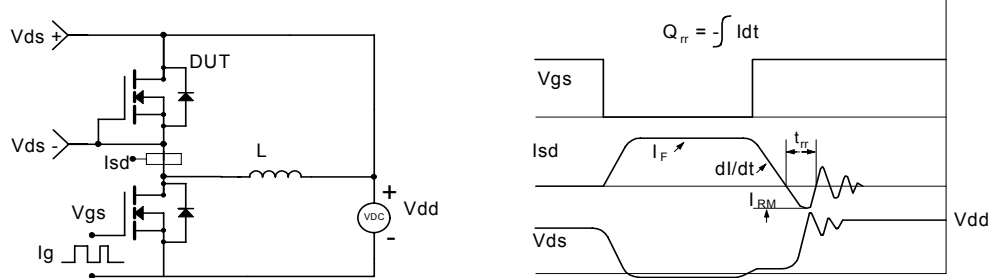
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



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